Effect of Interfacial Thermal Resistance in Thermal Cloak

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When heat transfers through interface between two different materials, it will encounter an interfacial thermal resistance (ITR) that makes the temperature discontinuous. However, this effect has been totally neglected when people build thermal cloaks with multilayer structures. In this paper, we investigate this problem by using both analytical and numerical method. Our results show that ITR brings both good news and bad news to the performance of thermal cloak. The good news is that ITR can reduce the heat flux in cloaking region, which is quite obvious. The bad news is that ITR limits the capability of the cloak to be invisible because of the external-field distortion. Moreover, we define a characteristic length to evaluate the effect of ITR. The external-field distortion can be removed by modifying thermal conductivity if the cloak size is larger than the characteristic length, otherwise the distortion always exists.

I. INTRODUCTION

Management and control of heat transfer such as refrigerating/air-conditioning and converting into electricity, has always been one of the most important issues not only in our daily life but also in further technology development [1]. Indeed, heat death - excess heat generation breaks down electronic devices - has been an outstanding problem for further development of microelectronics [2]. Recent years have witnessed an important progress in developing novel heat control methods. At the microscopic level, in analog with electronics, a new fast-growing field called phononics [3] has been emerged to manipulate heat conduction due to phonons in semiconductors and dielectric materials. At the macroscopic level, thermal metamaterials have been used to control both heat radiation [4, 5] and heat conduction [6]. The concept of thermal materials for manipulating heat conduction or sometimes also called transforming heat conduction [7] was inspired by the idea of transformation optics [5, 9], which provides a general method to realize complex control of heat flux, among which thermal cloak is of special interest. Two requirements are important in evaluating the performance of a thermal cloak: (i) the heat flux in the cloaking region should be as small as possible; (ii) the temperature distribution outside the cloak should be the same as the pure background to realize invisibility.

Transformation heat conduction [7] provides a general framework to design a perfect thermal cloak by using inhomogeneous and continuous parameters. However, practically it is nearly impossible to realize the continuity. As a good approximation, multilayer structures have been used to realize thermal cloaks [10–14]. Recently, Hwan et al even realized a multilayer thermal cloak at the microscale by using helium ion beam writing technique [15]. However, any attempt to use multilayer structures to approximate the continuous thermal cloak will introduce the Interfacial Thermal Resistance (ITR) or called Kapitza resistance [16–19], which has been ignored in all of those experiments.

In general, heat transfer through boundary between two different materials will encounter ITR and the effect is not negligible [16–19]. Moreover, at the nanoscale, the ITR becomes asymmetric and leads to thermal rectification [20]. ITR is the combination of two resistances: (i) thermal contact resistance (TCR) due to poor mechanical contact and (ii) thermal boundary resistance (TBR) due to differences in physical properties in different materials.

To make things simple, we consider the stationary thermal cloak first. In this case, The heat conduction equation is

$$\nabla \cdot (\kappa \nabla T) = 0. \quad (1)$$

Mathematically, this equation is the same as the stationary wave equation. This indeed has inspired Fan et al [21] to study stationary thermal cloak. However, a rigorous mathematical proof for transforming invariance for a general heat conduction equation - Fourier heat conduction equation, has been down in 2012 by Guenneau et al [7]. When ITR is considered, the temperature continuity is broken, and there exists a temperature drop on the interface [16–18]

$$T_{i+1}\mid_{\partial\Omega} = T_i\mid_{\partial\Omega} + R_{i,i+1} n \cdot (\kappa_i \nabla T_i) \mid_{\partial\Omega} \quad (2)$$

where $R_{i,i+1}$ is the ITR between the $i$th and $(i+1)$th layer, $n$ is the unit normal vector of the interface. As the thermal cloak and some other thermal devices are coming to nanoscale, we should notice that ITR can become significant. Therefore, it is quite natural to understand the effect of ITR in thermal cloaking.

In this paper, we investigate the IRT effect in the heat flux and temperature distribution, and further propose modifications to minimize and/or get rid of this effect.
The paper is organized as the following: in Section II, we discuss the effect on an anisotropic single layer cloak; in Section III, we discuss the case for bilayer cloak; and finally in the Section IV we give discussions.

II. ANISOTROPIC SINGLE LAYER CLOAK

First, we consider a single layer structure shown in Fig. 1, whose thermal conductivity is $\kappa_0$ in region I and III, $\kappa_r\kappa_0 = \kappa_o^2$ in region II. The whole structure is presented in a uniform thermal gradient field $\nabla T_b = G_0 \hat{x}$. Without loss of generality, we can set $T(x = 0, y) = 0$. The temperature potential can be expressed as

$$T_1 = \sum_{n=1}^{\infty} A_n r^n \cos n\theta$$  \hspace{1cm} (3)

$$T_2 = \sum_{n=1}^{\infty} [B_n r^n + C_n r^{-n}] \cos n\theta$$  \hspace{1cm} (4)

$$T_3 = \sum_{n=1}^{\infty} [D_n r^n + E_n r^{-n}] \cos n\theta$$  \hspace{1cm} (5)

where $l = \sqrt{\kappa_\theta/\kappa_r}$. Combining the boundary conditions Eq. (2) and $T_3|_{r \to \infty} = -G_0 r \cos \theta$, the solutions are

$$A_1 = -G_0 \left(\frac{a}{b}\right)^{l-1} \frac{1}{F}$$  \hspace{1cm} (7)

$$D_1 = -G_0$$  \hspace{1cm} (8)

$$E_1 = -\frac{G_0 b^2 H}{F}$$  \hspace{1cm} (9)

where

$$H = \frac{R_{12}\kappa_0}{2b} + \frac{R_{12}\kappa_0}{2b} a^{2l-1} b^{2l-1} + \frac{R_{12} R_{23}\kappa_0^2}{4ab} \left(1 - \frac{a^{2l}}{b^{2l}}\right)$$  \hspace{1cm} (10)

$$F = 1 + \frac{R_{12}\kappa_0}{2a} + \frac{R_{23}\kappa_0}{2b} a^{2l-1} b^{2l-1} + \frac{R_{12} R_{23}\kappa_0^2}{4ab} \left(1 - \frac{a^{2l}}{b^{2l}}\right)$$  \hspace{1cm} (11)

and all other $A_n$'s, $D_n$'s and $E_n$'s are zero. $A_1$ evaluates the heat flux in cloaking region and $E_1$ evaluates the field distortion outside the cloak. We are only interested in cloaking region and external region, so we don't explicitly give the solutions in region II. Let's assume $R_{12} = R_{23} = R_I$ since the material of region I and III are of the same in current structure. If there is no ITR ($R_I = 0, F = 1, H = 0$), these solutions are the same as those in Ref. [22].

In region I, the effect of ITR is introducing a scale factor $1/F$. Since $F \geq 1, 1/F \leq 1$. The heat flow in region I becomes smaller when considering ITR, which means better thermal shielding. We can further investigate the change of scale factor $1/F$ with respect to $l$. The ITR is usually in the range $10^{-9} \sim 10^{-7}$ K·m²/W [19]. Here we assume $R_I = 1 \times 10^{-7}$ K·m²/W, so we can plot the scale factor $1/F$ as a function of $l$, as shown in Fig. 2. The scale factor approaches a finite value as $l$ increases.

In region III, thermal cloak requires that there is no external-field distortion, which means $E_1$ should be zero. But from Eq. (9)-(11), we find $E_1 < 0$ as long as there is ITR. So the performance of thermal cloak is worse with respect to the external-field distortion when considering ITR.

An interesting feature of the factor $F$ and $H$ is that they define a characteristic length

$$L_c = R_I \kappa_0$$  \hspace{1cm} (12)

which is the product of ITR and background thermal conductivity. When the characteristic length $L_c$ is comparable to, or even greater than, the cloak size $a$ and $b$, both the reduction of heat flux in region I and external-field distortion in region III will become significant.

FIG. 1. Schematic of anisotropic single layer cloak.

![Schematic of anisotropic single layer cloak](image)

FIG. 2. $1/F$ as a function of $l$. $a = 0.5 \mu m, b = 1 \mu m, \kappa_0 = 1$ W/(m·K) and $R_I = 1 \times 10^{-7}$ K·m²/W have been used.

![Graph showing 1/F as a function of l](image)

Fig. 3 shows the results of numerical simulation. In Fig. 3(a) and 3(b), we can find that the heat flux in region I is smaller when considering ITR. By calculating the temperature difference with respect to the uniform thermal gradient field, it is clear that the external field is
Temperature at the left (right) boundary is fixed at 30 K (−30 K). $a = 0.5 \mu m$, $b = 1 \mu m$, $\kappa_0 = 1 W/(m-K)$, $\kappa_r = 0.3 W/(m-K)$, (a) $\kappa_0 = 3.3 W/(m-K)$, $R_I = 0 K-m^2/W$. (b) $\kappa_0 = 3.3 W/(m-K)$, $R_I = 1 \times 10^{-7} K-m^2/W$. (c) $\kappa_0 = 4.13 W/(m-K)$, $R_I = 1 \times 10^{-7} K-m^2/W$. (d) $\kappa_0 = 5 W/(m-K)$, $R_I = 1 \times 10^{-7} K-m^2/W$. (e)-(h) Temperature difference between the temperature distribution in (a)-(d) and the uniform thermal gradient field. Only the difference outside the cloak region is calculated because we want to study the external-field distortion.

To eliminate the external-field distortion, $E_t$ in Eq. (9) must be zero. This means $H(t)$ must have a root $t_0 > 0$. Since the first two terms in $H(t)$ are greater than zero and $H(l = 1) > 0$, the sufficient and necessary condition for $H(t)$ having a root $t_0 > 0$ is the coefficient of the third term is less than zero, i.e.

$$1 - \frac{R_I \kappa_0}{b} > 0,$$

and notice that $l = \sqrt{\kappa_0/\kappa_r} = t \kappa_0/\kappa_r$ is also $t$-dependent.

FIG. 3. Temperature distribution of the single layer structure. Temperature at the left (right) boundary is fixed at 30 K (−30 K). $a = 0.5 \mu m$, $b = 1 \mu m$, $\kappa_0 = 1 W/(m-K)$, $\kappa_r = 0.3 W/(m-K)$. (a) $\kappa_0 = 3.3 W/(m-K)$, $R_I = 0 K-m^2/W$. (b) $\kappa_0 = 3.3 W/(m-K)$, $R_I = 1 \times 10^{-7} K-m^2/W$. (c) $\kappa_0 = 4.13 W/(m-K)$, $R_I = 1 \times 10^{-7} K-m^2/W$. (d) $\kappa_0 = 5 W/(m-K)$, $R_I = 1 \times 10^{-7} K-m^2/W$. (e)-(h) Temperature difference between the temperature distribution in (a)-(d) and the uniform thermal gradient field. Only the difference outside the cloak region is calculated because we want to study the external-field distortion.

FIG. 4. Temperature distribution along $x$ axis. Parameters of Fig. 3(a) and 3(b) are used in (a) and (b) respectively. The upper right (lower left) inset shows the zoomed rectangle of Fig. 3(a) and 3(b) are used in (a) and (b) respectively. Discontinuity at the interface $a = \pm 0.5 \mu m$ and $b = \pm 1 \mu m$ can be clearly observed when considering ITR.

distorted in region III when considering ITR, as shown in Fig. 3(b) and 3(f).

Fig. 4 shows the temperature distribution of Fig. 3(a) and 3(b) along the $x$ axis. The discontinuity is obvious at the interface $a = 0.5 \mu m$ and $b = 1 \mu m$ in the existence of ITR.

Next, we would like to know if we can eliminate the external-field distortion by modifying thermal conductivity. A direct generalization of the original idea is using $\kappa_r \kappa_0 = t^2 \kappa_0^2$, where $t$ is a constant value to be determined, instead of $\kappa_r \kappa_0 = \kappa_0^2$. The new solutions of heat conduction equation hold the same forms of Eq. (7)-(9) except that now the factors $H$ and $F$ are functions of $t$,

$$F(t) = \frac{1}{4t} \left[ 1 - a^2 t^2 + 2 \left( 1 + \frac{a^2 t}{b^2} \right) \left( 1 + \frac{R_I \kappa_0}{2a} + \frac{R_I \kappa_0}{2b} \right) t \right]$$

and notice that $l = \sqrt{\kappa_0/\kappa_r} = t \kappa_0/\kappa_r$ is also $t$-dependent.

$$H(t) = \frac{1}{4} \left[ \left( 1 - \frac{a^2 t}{b^2} \right) + \left( 1 + \frac{a^2 t}{b^2} \right) \frac{R_I \kappa_0}{b} \frac{t}{t} \right]$$

and the root $t_0$ actually satisfies $t_0 > 1$. As an example, we choose the same geometry parameters and ITR as those in Fig. 3(b), so $L_c < b$ is satisfied. The root of $H(t)$
is $t_0 = 1.276$, which gives $\kappa_0 = t_0^2 \kappa_0^2 / \kappa_c = 4.13$ W/(m·K).

Fig. 3(c) and 3(g) show the numerical results using this modified thermal conductivity, where the external-field distortion is eliminated. Furthermore, it is easy to find that $F(t_0) > F(t = 1)$ (with the same $l$), which means the heat flux in cloaking region (region I) is smaller when using the modified thermal conductivity.

If we further increase $\kappa_3$, the external field is distorted again, as shown in Fig. 3(d) and 3(h). But this time the isothermal contour lines become outward curves, opposite to the inward curves in Fig. 3(b).

III. BILAYER CLOAK

![Fig. 5. Schematic of bilayer thermal cloak.](image)

Our second example is the bilayer cloak structure, as shown in Fig. 5, where $\kappa_i$ ($i = 1, 2, 3, 4$) is a scalar. $\kappa_1$ is the thermal conductivity of the cloaking object and $\kappa_4$ is that of background. The whole structure is presented in a uniform thermal gradient field $\nabla T_b = G_0 \hat{x}$. Similar to the anisotropic single layer case, the temperature in all the regions of space can be generally expressed as

$$T_i = \sum_{n=1}^{\infty} \left[ A^i_n r^n + B^i_n r^{-n} \right] \cos n\theta$$

(16)

where $A^i_n, B^i_n$ ($i = 1, 2, 3, 4$) are constant coefficients determined by the boundary conditions Eq. (2) and

$$T_1|_{r=0} = \text{finite}, \quad T_4|_{r=\infty} = -G_0 r \cos \theta$$

(17)

Considering that the inner layer is perfect insulation material, i.e., $\kappa_2 = 0$, this ensures that an external field does not penetrate inside the cloaking region and the only task is to eliminate the external-field distortion. Combining Eq. (2), (16), (17), we obtain

$$A^n_1 = -G_0$$

$$B^n_1 = -\frac{G_0 c_2}{(c^2 - b^2)(R_{34} \kappa_4 - c)\kappa_3 + c(b^2 + c^2)\kappa_4}$$

(18)

(19)

and all other $A^n_i$'s and $B^n_4$'s are zero. To eliminate the external-field distortion requires $B^n_4 = 0$, which means the numerator must be zero

$$(c^2 - b^2)(R_{34} \kappa_4 - c)\kappa_3 + c(b^2 + c^2)\kappa_4 = 0$$

(20)

We notice that $(c^2 - b^2) > 0$, $\kappa_3 > 0$, and $c(b^2 + c^2)\kappa_4 > 0$, so the existence of a solution requires

$$R_{34} \kappa_4 - c < 0, \quad R_{34} \kappa_4 < c$$

(21)

Eq. (21) again gives a relationship between the characteristic length $L_c$ and the cloak size $c$. Under this constraint, the solution of Eq. (20) gives

$$\kappa_3 = \frac{c^2 + b^2}{(c^2 - b^2)(1 - R_{34} \kappa_4/c)} \kappa_4$$

(22)

To verify the results above, we simulate the temperature distribution of the bilayer structure realized in Ref. [13], but with the cloak size $10^4$ times smaller. Fig. 6(a) shows the simulation result without ITR. If ITR is considered, the external field is significantly distorted, as shown in Fig. 6(b) and 6(f). We use Eq. (22) to eliminate the external-field distortion. Fig. 6(c) shows the temperature distribution with the modified thermal conductivity $\kappa_3$, where nearly no external-field distortion (see Fig. 6(g)) is observed. If we further increase $\kappa_3$, the external field is distorted again, as shown in Fig. 6(d). But this time the isothermal contour lines become outward curves, opposite to the inward curves in Fig. 6(b). This behaviour is similar to what we find in Section II.

In cloaking region ($r < a$), the average heat flux is calculated via

$$\overline{|q|} = \frac{1}{\pi a^2} \int_{r<a} |q| \, dxdy$$

(23)

to compare the shielding performance of thermal cloak. The result is $\overline{|q|}_{(b)} / \overline{|q|}_{(a)} = 0.88$, $\overline{|q|}_{(c)} / \overline{|q|}_{(a)} = 0.79$, where the subscript (a), (b), (c) denotes the case of Fig. 6(a), 6(b), 6(c) respectively. This indicates the reduction of heat flux when considering ITR.

Next, we further consider the experiment in Ref. [15], where they use crystalline and amorphous silicon to realize thermal cloak at microscale. ITR between crystalline and amorphous silicon at 300 K is about $1 \times 10^{-9}$ K·m²/W [23]. As shown in Fig. 7, ITR only introduces very small difference to the temperature distribution, which means it is a good approximation to ignore ITR in their experiment. This is easy to understand since the characteristic length $L_c = R_{14} \kappa_4 \approx 4 \times 10^{-8}$ m is much less than the cloak size $c = 10 \mu$m ($10^{-5}$ m). But if the cloak size decreases to the order of $0.1 \mu$m ($10^{-7}$ m), i.e. 100 times smaller, the effect of ITR will become significant.

IV. CONCLUSION AND DISCUSSIONS

In this paper, we have studied the effect of ITR in stationary thermal cloak. In the two structures we in-
FIG. 6. Temperature distribution of the bilayer structure. Temperature at the left (right) boundary is fixed at 333 K (273 K). \( a = 0.6 \mu m, b = 0.95 \mu m, c = 1.2 \mu m, \kappa_1 = 27 \) W/(m·K), \( \kappa_2 = 0.03 \) W/(m·K), \( \kappa_4 = 2.3 \) W/(m·K). (a) \( \kappa_3 = 9.8 \) W/(m·K), \( R_{34} = 0 \) K·m²/W. (b) \( \kappa_3 = 9.8 \) W/(m·K), \( R_{34} = 1 \times 10^{-7} \) K·m²/W. (c) \( \kappa_3 = 12.4 \) W/(m·K) determined by Eq. (29), \( R_{34} = 1 \times 10^{-7} \) K·m²/W. (d) \( \kappa_3 = 15 \) W/(m·K), \( R_{34} = 1 \times 10^{-7} \) K·m²/W. (e)-(h) Temperature difference between the temperature distribution in (a)-(d) and uniform thermal gradient field. Only the difference outside the cloak region is calculated because we want to study the external-field distortion.

FIG. 7. Temperature distribution of the thermal cloak realized in Ref. [15]. \( a = 5.55 \mu m, b = 6.1 \mu m, c = 10 \mu m, \kappa_1 = \kappa_4 = 40 \) W/(m·K), \( \kappa_2 = 2 \) W/(m·K), \( \kappa_3 = 65 \) W/(m·K). (a) without ITR. (b) with ITR. (c) Temperature difference \( (T_b - T_a) \) between (a) and (b).

Investigated, ITR reduces the heat flux in the cloaking region while distorts the temperature distribution outside the cloak. We have introduced a characteristic length that is the product of the ITR and background thermal conductivity. The effect of ITR becomes significant when the characteristic length is comparable to the cloak size. If the characteristic length is smaller than the cloak size, we can modify the thermal conductivity to eliminate the external-field distortion. Although the structures we have studied are simple, it is straightforward to generalize our analysis to more complex multilayer structures. We believe the reduction of heat flux in the cloaking region is generic, and to eliminate the external-field distortion is still possible in specific conditions.

In no stationary thermal cloak, Sklan et al [24] have demonstrated that the bilayer cloak can be detected by transient temperature distribution. We also investigate the thermal cloak with ITR and modified thermal conductivity, and find almost the same transient effect, which means ITR cannot be used to remove the transient effect.